A, W, H, McL & N Docket No.____

ARMSTRONG, WESTERMAN, HATTORI, McLeland & Naughton

Declaration For U.S. Patent Application

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

the specification of	which is attached hereto unless the follo	wing is checked:		
w	as filed on	as United States Application Number or PCT Internationaland was amended on		
A	pplication Number			
(in	f applicable).			
I hereby state that I by any amendment	have reviewed and understand the contereferred to above.	ents of the above-identified	I specification, including the clair	n(s), as amended
I acknowledge the d	uty to disclose information which is mate	erial to patentability as defin	ned in Title 37, Code of Federal R	egulations, § 1.56
inventor's certificat	gn priority benefits under Title 35, Unit e listed below and have also identified b of the application on which priority is c	elow any foreign applicati		cate having a fil-
# #	2001-78712	Japan	19/03/2001	Priority Claime Yes I No
(List prior foreign	(Number)	(Country)	(Day/Month/Year Filed)	_
applications. See note A	(Number)	(Country)	(Day/Month/Year Filed)	_
on back of this page)	(Number)	(Country)	(Day/Month/Year Filed)	_ Q Yes Q No
	(Number)	(Country)	(Day/Month/Year Filed)	
See note B on back	c of this page)	ed list for additional prior	foreign applications	
ari ri i i i	enefit under Title 35, United States Cod	e, § 119(e) of any United	States provisional application(s) l	isted below.
i nereby claim the t				
nereby claim the t	(Application Number)	(Filing Date)	
i nereby claim the t	(Application Number		(Filing Date)	
nereby claim the t	(Application Number		(Filing Date) (Filing Date)	
I hereby claim the b subject matter of ea the first paragraph o ity as defined in Tit		le, § 120 of any United Sta t disclosed in the prior Un acknowledge the duty to d 56 which became available	(Filing Date) ates application(s) listed below an ited States application in the man lisclose information which is mate	mer provided by erial to patentabi
I hereby claim the b subject matter of ea the first paragraph o ity as defined in Tit	(Application Number penefit under Title 35, United States Cook of the claims of this application is not fittle 35, United States Code, § 112, I le 37, Code of Federal Regulations, § 1.	le, § 120 of any United Sta t disclosed in the prior Un acknowledge the duty to d 56 which became available	(Filing Date) ates application(s) listed below an ited States application in the man lisclose information which is mate	ner provided by erial to patentabi rior application

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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